APPLICA	BLE STAN	IDARD								
	OPERATING TEMPERATURE RANGE		-35 °C TO +85 °C (NOTES 1) $_{TE}$			MPERATURE RANGE		-10 °C TO +60 °C (NOTE2)		
RATING	VOLTAGE		250 V AC		APPLICA CONNEC			DF1E- * S-2. 5C		
	CURRENT		AWG20 TO 24: 3A			VOLTAG	E	AC 30V		_
			AWG26: 2A AWG28: 1A AWG30: 0.5A		UL, CSA	CURRENT		AWG20 TO 22: AWG24 TO 28:		
		SPECIFIC			TIONS	IC		AWG30:	J. 5A	
17	EM		TEST METHOD	II ICA	HONG)	REOL	JIREMENTS	QT	AT
	UCTION		TEOT METHOD				- NE GO	, inclivillation		1 / ()
GENERAL E	XAMINATION	VISUALL	Y AND BY MEASURING IN	NSTRUMEN	NT. AC	CORDING	TO DE	RAWING.	Х	X
MARKING			MED VISUALLY.						X	X
	IC CHARA									
CONTACT RESISTANCE MILLIVOLT LEVEL METHOD.		20 mV MAX, 1 mA(DC OR 1000 Hz).			30	30 mΩ MAX.				-
INSULATION RESISTANCE		500 V DC.			100	1000 MΩ MIN.				-
		650 V AC FOR 1 min.			NO	NO FLASHOVER OR BREAKDOWN.				-
MECHAN	IICAL CHA	ARACTE	RISTICS						I	1
MECHANICAL OPERATION		30 TIMES INSERTIONS AND EXTRACTIONS.			2 1	 ① CONTACT RESISTANCE: 30 mΩ MAX. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS. 			Х	_
VIBRATION		· · · · · · · · · · · · · · · · · · ·				① NO ELECTRICAL DISCONTINUITY OF 1 μs. ② NO DAMAGE, CRACK OR LOOSENESS OF			Х	_
		490 m/s ² DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.				PARTS.			Х	_
ENVIRO	NMENTAL	.CHARA	CTERISTICS							
RAPID CHANGE OF TEMPERATURE		TIME $30 \rightarrow 5 \text{ MAX} \rightarrow 30 \rightarrow 5 \text{ MAX} \text{ min}$			min 2 1	 CONTACT RESISTANCE: 30 mΩ MAX. INSULATION RESISTANCE: 1000 MΩ MIN. NO DAMAGE, CRACK OR LOOSENESS OF PARTS. 				_
DAMP HEAT (STEADY STATE)		EXPOSED AT 40 ± 2 °C, 90 TO 95 %, 96 h.			① (2) I ③ I	CONTACT RESISTANCE: 30 mΩ MAX. INSULATION RESISTANCE: 500 MΩ MIN. NO DAMAGE, CRACK OR LOOSENESS OF PARTS.				-
SOLDERING HEAT		SOLDER TEMPERATURE, 260 °C FOR IMMERSION, DURATION, 10 sec. 2) MANUAL SOLDERING SOLDERING IRON TEMPERATURE: 300 °C, SOLDERING TIME: 3 sec. NO STRENGTH ON CONTACT.				NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.				_
SOLDERABILITY			SOLDERED AT SOLDER TEMPERATURE, 235 °C FOR IMMERSING DURATION, 5 s.			SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.			X	_
COUN	T DI	ESCRIPTIO	ON OF REVISIONS		DESIGNE	D		CHECKED	DA	TE
<u> </u>										
	JDE THE TEMP	PERATURE F	RATURE RISING BY CURRENT. TION OF LONG TERM STORAGE FOR UNUSED PRODUCTS D,AFTER PCB BOARD,OPERATING TEMPERATURE AND			APPROVED CHECKED		KI. AKIYAMA	15. 05. 23 15. 05. 23	
	Y TO THE CONI							TS. FUKUSHIMA		
			OR INTERIM STORAGE DURING TRANSPORTATI					TS. KUMAZAWA		
	,					DRAWN		MI. SAKIMURA		
Note QT:Qualification Test AT:Assurance Test X:Applic				e Test D		RAWING NO.		ELC-161943-35-00		
HS.			CATION SHEET		PART NO).	DF1EC-*P-2. 5DSA (35		•	
		OSF FL	E ELECTRIC CO., LTD.		CODE NO)	CL541		Δ	1/1